

**REMARKS**

Favorable consideration and allowance of the claims of the present application are respectfully requested.

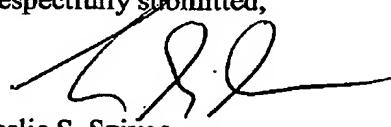
In the present Official Action, Claims 1-20 which are present in the above-captioned application have been subjected to a restriction under 35 U.S.C. §121 as follows:

- I.      Claims 18-20, drawn to a semiconductor structure, classified in Class 257, subclass 506; and
- II.     Claims 1-17, drawn to a method of forming a layer of Si, classified in Class 438, subclass 296.

As indicated, and in order to be fully responsive to the restriction requirement imposed in the present Official Action, applicants provisionally elect, without traverse, to prosecute the subject matter of Group II, i.e., Claims 1-17, and reserve the right to file one or more divisional applications directed to the non-elected subject matter in this application, i.e., Claims 18-20.

Wherefore, consideration and allowance of the claims of the present application are respectfully requested.

Respectfully submitted,



Leslie S. Szivos  
Registration No. 39,394

SCULLY, SCOTT, MURPHY & PRESSER, P.C.  
400 Garden City Plaza, Suite 300  
Garden City, New York 11530  
(516) 742-4343  
**Customer No. 23389**  
LSS:vh